WIMA MKP-X2 R <mark>NEW</mark>



Special Features

- Reliable self-healing
- Increased corona inception level due to internal series connection
- High degree of interference suppression due to good attenuation and low ESR
- According to RoHS 2002/95/EC

Typical Applications

Class X2 RFI applications to meet EMC regulations

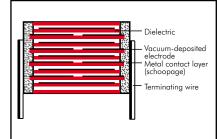
- Capacitors connected to the mains between phase and neutral or phase conductors
- Installation category II in accordance with IEC 60664, pulse peak voltage ≤ 2.5 kV

As capacitor voltage divider in applications requiring a high capacitance stability over time

Construction

Dielectric:

Polypropylene (PP) film Capacitor electrodes: Vacuum-deposited Internal construction:



Encapsulation:

Solvent-resistant, flame-retardant plastic case with epoxy resin seal, UL 94 V–0 **Terminations:**

Tinned wire.

Marking: Colour: Red. Marking: Black.

Electrical Data

Capacitance range: 0.033 µF to 1.5 µF Rated voltage: 400 VAC Continuous DC voltage* (general guide): ≤ 1000 V Capacitance tolerances: ±20%, ±10% (±5% available subject to special enquiry) Operating temperature range: -55° C to +105° C

Climatic test category: 55/105/56/C in accordance with IEC **Insulation resistance** at +20° C:

 $\begin{array}{l} C \leqslant 0.33 \ \mu\text{F} \geqslant 15 \times 10^3 \ \text{M}\Omega \\ C > 0.33 \ \mu\text{F} \geqslant 5000 \ \text{sec} \ (\text{M}\Omega \times \mu\text{F}) \\ \text{Measuring voltage: } 100 \ \text{V/1 min.} \\ \end{array}$

Test specifications:

In accordance with DIN EN 60384-14 **Maximum pulse rise time:** 100 V/µsec for pulses equal to a voltage amplitude with $\sqrt{2} \times 400$ VAC = 565 V

according to IEC 60384-14

Test voltage:

 $\label{eq:constraint} \begin{array}{l} C \leqslant 1.0 \ \mu\text{F}\text{:} 2260 \ \text{VDC}\text{,} 2 \text{sec.} \\ C > 1.0 \ \mu\text{F}\text{:} 1800 \ \text{VDC}\text{,} 2 \text{sec.} \end{array}$

Reliability:

Operational life > 300 000 hours Failure rate < 2 fit (0.5 x U_r and 40° C)

at f	C ≤ 0.1 µF	0.1 µF < C ≤ 1.0 µF	C > 1.0 µF		
1 kHz	≤ 8 x 10 ⁻⁴	≤ 8 x 10 ⁻⁴	≤ 10 x 10 ⁻⁴		
10 kHz	$\leq 12 \times 10^{-4}$	$\leq 12 \times 10^{-4}$	-		
100 kHz	≤ 25 x 10 ⁻⁴	-	-		

Mechanical Tests

Pull test on leads:

10 N in direction of leads according to IEC 60068-2-21 **Vibration:**

6 hours at 10 ... 2000 Hz and 0.75 mm displacement amplitude or 10 g in

accordance with IEC 60068-2-6 Low air density:

1kPa = 10 mbar in accordance with IEC 60068-2-13 **Bump test:**

4000 bumps at 390 m/sec² in accordance with IEC 60068-2-29

 * The permissible pulse rise time du/dt (Fmax.) will be subject to a reduction according to

 $F_{max.} = F_r \times \sqrt{2} \times UAC / UDC$

if the DC operating voltage UDC is higher than $\sqrt{2}\ x$ UAC

Packing

Available taped and reeled up to and including case size 15 x 26 x 31.5 / PCM 27.5 mm.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

WIMA MKP-X2 R

Continuation



General Data

Carponaitanaa	400 VAC*					
Capacitance	W	Н	L	PCM**		
0.033 µF	5	11	18	15		
0.047 "	5	11	18	15		
0.068 "	6	12.5	18	15		
0.1 µF	8	15	18	15*		
	6	15	26.5	22.5*		
0.15 "	9	16	18	15*		
	7	16.5	26.5	22.5*		
0.22 "	8.5	18.5	26.5	22.5		
0.33 "	10.5	19	26.5	22.5		
0.47 "	11	21	26.5	22.5		
0.68 "	13	24	31.5	27.5		
1.0 µF	15	26	31.5	27.5		
1.5 "	17	29	31.5	27.5		

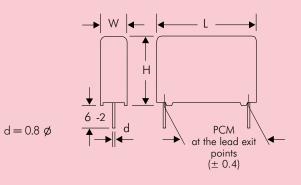
* f = 50/60 Hz

** PCM = Printed circuit module = lead spacing

* On ordering please state the required <u>PCM</u>. If not specified, smaller PCM will be booked.

Taped version see page 121.

Dims. in mm.



Rights reserved to amend design data without prior notification.

Recommendation for Processing and Application of **Through-Hole Capacitors**

Soldering Process

A preheating of through-hole WIMA capacitors is allowed for temperatures $T_{max} < 100 \circ C.$ In practice a preheating duration of t < 5 min. has been proven to be best.

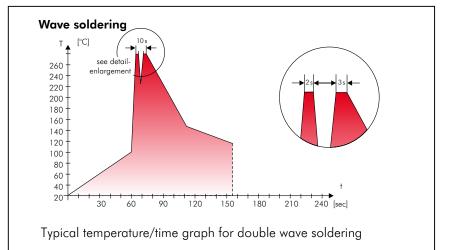
Single wave soldering

Soldering bath temperature: $T < 260 \,^{\circ}\,C$ Immersion time: t < 5 sec

Double wave soldering

Soldering bath temperature: $T < 260 \,^{\circ}\,C$ Immersion time: $2 \times t < 3 \sec$

Due to different soldering processes and heat requirements the graphs are to be regarded as a recommendation only.



WIMA Quality and Environmental Philosophy

ISO 9001:2000 Certification

ISO 9001:2000 is an international basic standard of quality assurance systems for all branches of industry. The approval according to ISO 9001:2000 of our factories by the VDE inspectorate certifies that organisation, equipment and monitoring of quality assurance in our factories correspond to internationally recognized standards.

WIMA WPCS

The WIMA Process Control System (WPCS) is a quality surveillance and optimization system developed by WIMA. WPCS is a major part of the quality-oriented WIMA production. Points of application of WPCS during production process:

- incoming material inspection
- metallization
- film inspection
- schoopage
- pre-healing lead attachment
- cast resin preparation/ encapsulation
- 100% final inspection
- AQL check

WIMA Environmental Policy

All WIMA capacitors, irrespective of whether through-hole devices or SMD, are made of environmentally friendly materials. Neither during manufacture nor in the product itself any toxic substances are used, e.g.

- PBB/PBDE

- Arsenic

- Mercurv

- etc.

– Lead

- PCB
- CFC
- Hydrocarbon chloride
- Chromium 6+

We merely use pure, recyclable materials for packing our components, such as:

- carton
- cardboard
- adhesive tape made of paper
- polystyrene

We almost completely refrain from using packing materials such as:

- foamed polystyrene (Styropor®)
- adhesive tapes made of plastic
- metal clips

RoHS Compliance

According to the RoHS Directive 2002/95/EC certain hazardous substances like e.g. lead, cadmium, mercury must not be used any longer in electronic equipment as of July 1st, 2006. For the sake of the environment WIMA has refraind from using such substances since years already.



Tape for lead-free WIMA capacitors

DIN EN ISO 14001:2005

WIMA's environmental management has been established in accordance with the guidelines of DIN EN ISO 14001:2005. The certification has been granted in June 2006.



Typical Dimensions for Taping Configuration

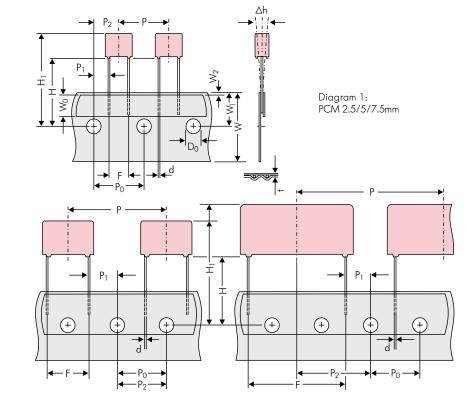


Diagram 2: PCM 10/15 mm

Diagram 3: PCM 22.5 and 27.5*mm *PCM 27.5 taping possible with two feed holes between components

		Dimensions for Radial Taping							
Designation	Symbol	PCM 2.5 taping	PCM 5 taping	PCM 7.5 taping	PCM 10 taping*	PCM 15 taping*	PCM 22.5 taping	PCM 27.5 taping	
Carrier tape width	W	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	18.0 ±0.5	
Hold-down tape width	W ₀	6.0 for hot-sealing adhesive tape	6.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	12.0 for hot-sealing adhesive tape	
Hole position	W1	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	9.0 ±0.5	
Hold-down tape position	W ₂	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	0.5 to 3.0 max.	
Feed hole diameter	D ₀	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	4.0 ±0.2	
Pitch of component	Р	12.7 ±1.0	12.7 ±1.0	12.7 ±1.0	25.4 ±1.0	25.4 ±1.0	38.1 ±1.5	38.1 ±1.5 or 50.8 ±1.5	
Feed hole pitch	Po	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	12.7 ±0.3 cumulative pitch error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	cumulative pitch 12.7 ±0.3 error max. 1.0 mm/20 pitch	
Feed hole centre to lead	P1	5.1 ±0.5	3.85 ±0.7	2.6 ±0.7	7.7 ±0.7	5.2 ±0.7	7.8 ±0.7	5.3 ±0.7	
Hole centre to component centre	P ₂	6.35 ±1.3	6.35 ±1.3	6.35 ±1.3	12.7 ±1.3	12.7 ±1.3	19.05 ±1.3	19.05 ±1.3	
Feed hole centre to bottom	Н▲	16.5 ±0.3	16.5 ±0.3	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	16.5 ±0.5	
edge of the component		18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	18.5 ±0.5	
Feed hole centre to top edge of the component	H1	H+H _{component} < H ₁ 32.25 max.	H+H _{component} < H ₁ 32.25 max.	H+H _{component} < H ₁ 24.5 to 31.5	H+H _{component} < H ₁ 25.0 to 31.5	H+H _{component} < H ₁ 26.0 to 37.0	H+H _{component} < H ₁ 30.0 to 43.0	H+H _{component} < H ₁ 35.0 to 45.0	
Lead spacing at upper edge of carrier tape	F	2.5 ±0.5	5.0 ^{+0.8} _{-0.2}	7.5 ±0.8	10.0 ±0.8	15 ±0.8	22.5 ±0.8	27.5 ±0.8	
Lead diameter	d	0.4 ±0.05	0.5 ±0.05	$^{\circ}0.5 \pm 0.05 \text{ or } 0.6 + 0.06 \\ -0.05 $	$^{\circ}0.5 \pm 0.05 \text{ or } 0.6 + 0.06 - 0.05$	0.8 +0,08	0.8 +0,08	0.8 +0.08 -0.05	
Component alignment	Δh	± 2.0 max.	± 2.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	± 3.0 max.	
Total tape thickness	t	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	0.7 ±0.2	
		ROLL/AMMO		AMMO					
Package (see also page 122)	•	REEL Ø 360 max. Ø 30 ±1	$\left. B \begin{array}{c} 52 \pm 2 \\ 58 \pm 2 \end{array} \right\} \begin{array}{c} \text{depending on} \\ \text{comp. dimensions} \end{array}$	s REEL $\begin{pmatrix} \phi & 360 \text{ max.} \\ \phi & 30 \pm 1 \\ \phi & 30 \pm 1 \\ \end{pmatrix}$ B 58 $\pm 2 \text{ or }$ REEL $\begin{pmatrix} \phi & 500 \text{ max.} \\ \phi & 25 \pm 1 \\ 66 \pm 2 \\ \end{pmatrix}$ B 50 $\pm 2 \text{ or }$ REEL $\begin{pmatrix} \phi & 500 \text{ max.} \\ B & 60 \pm 2 \\ 68 \pm 2 \\ \end{pmatrix}$ depending on POV and component dimensions					
Unit		see details page 124.							

 \blacktriangle Please give "H" dimensions and desired packaging type when ordering.

• Diameter of leads see General Data.

PCM 10 and PCM 15 can be crimped to PCM 7.5. Position of components according to PCM 7.5 (sketch 1). $P_0 = 12.7$ or 15.0 is possible

Please clarify customer-specific deviations with the manufacturer.

Dims in mm.